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LET9045F

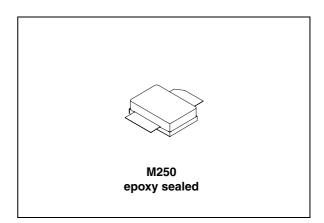
RF power transistor from the LdmoST family of n-channel enhancement-mode lateral MOSFETs

Features

- Excellent thermal stability
- Common source configuration
- P_{OUT} (@28 V) = 45 W with 18.5 dB gain @ 960 MHz
- P_{OUT} (@36V) = 70 W with 18.5 dB gain @ 960 MHz
- BeO free package
- In compliance with the 2002/95/EC European directive

Description

The LET9045F is a common source n-channel enhancement-mode lateral field-effect RF power transistor designed for broadband commercial and industrial applications at frequencies up to 1.0 GHz. The LET9045F is designed for high gain and broadband performance operating in common source mode at 28 V. It is ideal for base station applications requiring high linearity.





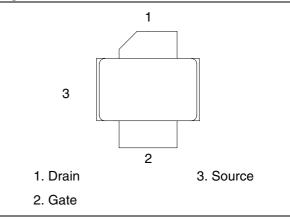


Table 1. Device summary

Order code	Package	Branding
LET9045F	M250	LET9045F

1 Maximum ratings

	Absolute maximum ratings (TCASE = 25°C)		
Symbol	Parameter	Value	Unit
V _{(BR)DSS}	Drain-source voltage	80	V
V _{GS}	Gate-source voltage	-0.5 to +15	V
۱ _D	Drain current	9	А
P _{DISS}	Power dissipation (@ $T_C = 70 \ ^{\circ}C$)	108	W
TJ	Max. operating junction temperature	200	°C
T _{STG}	Storage temperature	-65 to +150	°C

Table 2.Absolute maximum ratings ($T_{CASE} = 25 \ ^{\circ}C$)

	Table 3.	Thermal	data
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Symbol	Parameter	Value	Unit
R _{th(JC)}	Junction-case thermal resistance	1.2	°C/W



2 Electrical characteristics

T_C = 25 °C

Table 4. Static

Symbol	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	V_{GS} = 0 V; I _{DS} = 10 mA	80			V
I _{DSS}	$V_{GS} = 0 V; V_{DS} = 28 V$			1	μA
I _{GSS}	$V_{GS} = 20 \text{ V}; \text{ V}_{DS} = 0 \text{ V}$			1	μA
V _{GS(Q)}	$V_{DS} = 28 \text{ V}; \text{ I}_{D} = 300 \text{ mA}$	2.0		5.0	V
V _{DS(ON)}	$V_{GS} = 10 \text{ V}; \text{ I}_{D} = 3 \text{ A}$		0.9	1.2	V
G _{FS}	V _{DS} = 10 V; I _D = 3 A	2.5			mho
C _{ISS}	$V_{GS} = 0 \text{ V}; \text{ V}_{DS} = 28 \text{ V}; \text{ f} = 1 \text{ MHz}$		58		pF
C _{OSS}	$V_{GS} = 0 \text{ V}; \text{ V}_{DS} = 28 \text{ V}; \text{ f} = 1 \text{ MHz}$		29		pF
C _{RSS}	$V_{GS} = 0 V; V_{DS} = 28 V; f = 1 MHz$		0.8		pF



Symbol	Test conditions	Min.	Тур.	Max.	Unit
P _{OUT}	V_{DD} = 28 V; I_{DQ} = 300 mA; P_{IN} = 1 W; f = 960 MHz	45	59		W
G _{PS}	V_{DD} = 28 V; I_{DQ} = 300 mA; P_{IN} = 1 W; f = 960 MHz	16.5	17.7		dB
h _D	V_{DD} = 28 V; I_{DQ} = 300 mA; P_{IN} = 1 W; f = 960 MHz	60	65		%
Load mismatch	V_{DD} = 28 V; I_{DQ} = 300 mA; P_{IN} = 1 W; f = 960 MHz All phase angles	10:1			VSWR



3 Impedance data

Figure 2. Impedance data

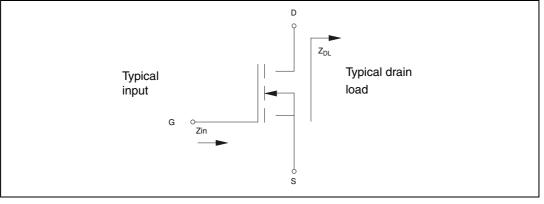


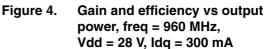
Table 6.Impedance data

Frequency	Z _{IN} (Ω)	Ζ_{DL} (Ω)
920	0.8 - j 0.08	5.3 + j 0.63
945	0.7 - j 0.4	5 + j 1.5
960	0.6 - j 0.6	4.7 + j 2



4 Typical performances

Figure 3. Gain vs output power and bias F current, freq = 960 MHz, Vdd = 28 V



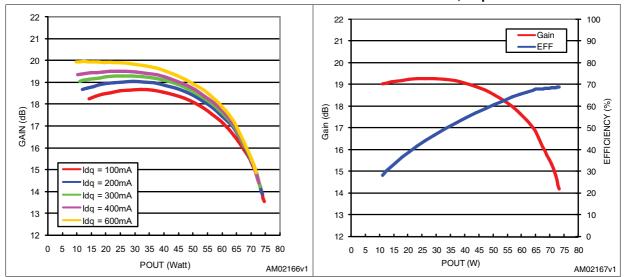
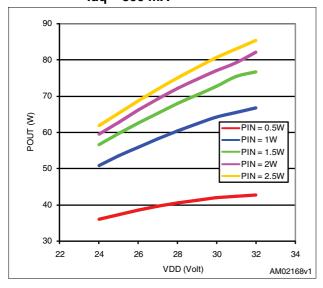


Table 7.Output power vs supply voltage
freq = 960 MHz, Vdd = 28 V,
Idq = 300 mA



5 Test circuit



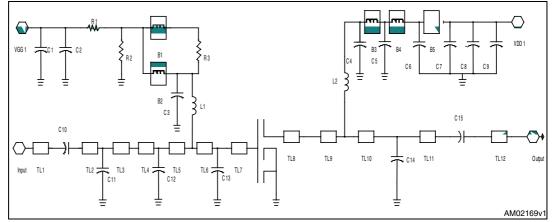


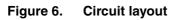
Image: Market	Table 0.					
R31CR1206-8W-100JBVENKEL10 Ω 1/8W surface mount chip resistorCoil2BELDENInductor 5 turns air WOUND#20AWG ID =0.130 in (3.3 mm) bylon coatedB1,B2,B 3,B4,B552743021447FAIR-RITE CORPSurface mount EMI sheild beadC1,C7, C83T491D106K035ATKemet10 µF 35 V tantalum capacitorsC211100 µF 63 V electrolytic capacitorC3, C4, C154ATC100B470XXXXATC47 pF chip capacitorC5, C62ATC200B393MWATC39000 pF chip capacitorC91330 µF 50 V electrolytic capacitorC11, C13, C14327291PCJohansonC121ATC100B110XXXXATC11 pF chip capacitorC141L = 0.144in [3.65 mm] W = 0.082in [02.08 mm]TL21L = 0.82in [2.09 mm] W = 0.323in [08.21 mm]	Item	Qty	Part number	Vendor	Description	
Coil 2 Inductor S turns air WOUND#20AWG ID =0.130 in (3.3 mm) bylon coated B1,B2,B 3,B4,B5 5 2743021447 FAIR-RITE CORP Surface mount EMI sheild bead C1,C7, C8 3 T491D106K035AT Kemet 10 μF 35 V tantalum capacitors C2 1 100 μF 63 V electrolytic capacitor C3,C4, C10, C15 4 ATC100B470XXXX ATC 4 ATC100B470XXXX ATC 39000 pF chip capacitor C5,C6 2 ATC200B393MW ATC 39000 pF chip capacitor C11, C13, C14 3 27291PC Johanson 0.8-8 pF giga trim variable capacitor C12 1 ATC100B110XXXX ATC 11 pF chip capacitor C12 1 ATC100B110XXXX ATC 11 pF chip capacitor C12 1 ATC100B110XXXX ATC 11 pF chip capacitor TL2 1 ATC100B110XXXX ATC 11 pF chip capacitor TL3 3 27291PC Johanson 0.8-8 pF giga trim variable capacitor TL1 I I	R1, R2	2	CR1206-8W-112JB	VENKEL	1.1 k Ω 1/8W surface mount chip resistor	
Coil2BELDENair WOUND#20AWG ID =0.130 in (3.3 mm) bylon coatedB1,B2,B 3,B4,B552743021447FAIR-RITE CORPSurface mount EMI sheild beadC1,C7, C83T491D106K035ATKemet10 µF 35 V tantalum capacitorsC21100 µF 63 V electrolytic capacitorC3,C4, C10, C154ATC100B470XXXXATCC5,C62ATC200B393MWATC39000 pF chip capacitorC5,C62ATC200B393MWATC330 uF 50 V electrolytic capacitorC91330 uF 50 V electrolytic capacitorC11, C13, C14327291PCJohanson0.8-8 pF giga trim variable capacitorC121ATC100B110XXXXATC11 pF chip capacitorTL11L = 0.311in [7.91 mm] W = 0.082in [02.08 mm]TL314Ichem IdIchem IdL = 0.082in [2.09 mm] W = 0.323in [08.21 mm]	R3	1	CR1206-8W-100JB	VENKEL	10 Ω 1/8W surface mount chip resistor	
3,B4,B552743021447CORPSurface mount Elvin sheld bead $C1,C7, C8$ 3T491D106K035ATKemet10 µF 35 V tantalum capacitors $C2$ 1100 µF 63 V electrolytic capacitor $C3, C4, C10, C15$ 4ATC100B470XXXXATC47 pF chip capacitor $C5, C6$ 2ATC200B393MWATC39000 pF chip capacitor $C9$ 1330 uF 50 V electrolytic capacitor $C11, C13, C14$ 327291PCJohanson0.8-8 pF giga trim variable capacitor $C12$ 1ATC100B110XXXXATC11 pF chip capacitor $TL1$ L $L = 0.311in [7.91 mm] W = 0.082in [02.08 mm]$ $TL3$ L $L = 0.82in [2.09 mm] W = 0.323in [08.21 mm]$	Coil	2		BELDEN	air WOUND#20AWG ID =0.130 in (3.3 mm) bylon	
C831491D106K03SATKemet10 μ F 35 V tantalum capacitorsC21100 μ F 63 V electrolytic capacitorC3, C4, C10, C154ATC100B470XXXXATC47 pF chip capacitorC5, C62ATC200B393MWATC39000 pF chip capacitorC911330 μ F 50 V electrolytic capacitorC11, C13, C14327291PCJohanson0.8-8 pF giga trim variable capacitorC121ATC100B110XXXXATC11 pF chip capacitorTL111L = 1.350in [34.29 mm] W = 0.082in [02.08 mm]TL21ATC100B 102XXXL = 0.144in [3.65 mm] W = 0.082in [02.08 mm]TL311L = 0.311in [7.91 mm] W = 0.082in [02.08 mm]TL411L = 0.0.82in [2.09 mm] W = 0.323in [08.21 mm]		5	2743021447		Surface mount EMI sheild bead	
C3, C4, C10, C15 4 ATC100B470XXXX ATC 47 pF chip capacitor C5, C6 2 ATC200B393MW ATC 39000 pF chip capacitor C9 1 330 uF 50 V electrolytic capacitor C11, C13, C14 3 27291PC Johanson 0.8-8 pF giga trim variable capacitor C12 1 ATC100B110XXXX ATC 11 pF chip capacitor TL1 1 ATC100B110XXXX ATC 11 pF chip capacitor TL1 1 ATC100B110XXXX ATC 11 pF chip capacitor TL2 1 ATC100B110XXXX ATC 11 pF chip capacitor TL2 1 Image: Arrow of the section		3	T491D106K035AT	Kemet	10 µF 35 V tantalum capacitors	
C10, C154ATC100B470XXXXATC47 pF chip capacitorC5, C62ATC200B393MWATC39000 pF chip capacitorC91330 uF 50 V electrolytic capacitorC11, C13, C14327291PCJohanson0.8-8 pF giga trim variable capacitorC121ATC100B110XXXXATC11 pF chip capacitorTL11ATC100B110XXXXATC11 pF chip capacitorTL11IIIITL21ATC100B110XXXXATC11 pF chip capacitorTL31IIIITL31IIIITL41IIIITL41IIIITL41IIIITL41IIIITL41IIIITL41IIIITL41IIIITL41IIIITL41IIIITL41II <t< td=""><td>C2</td><td>1</td><td></td><td></td><td>100 µF 63 V electrolytic capacitor</td></t<>	C2	1			100 µF 63 V electrolytic capacitor	
C9 1 330 uF 50 V electrolytic capacitor C11, C13, C14 3 27291PC Johanson 0.8-8 pF giga trim variable capacitor C12 1 ATC100B110XXXX ATC 11 pF chip capacitor TL1 1 Image: Color of the state o	C10,	4	ATC100B470XXXX	ATC	47 pF chip capacitor	
C11, C13, C14 3 27291PC Johanson 0.8-8 pF giga trim variable capacitor C12 1 ATC100B110XXXX ATC 11 pF chip capacitor TL1 1 ATC100B110XXXX ATC 11 pF chip capacitor TL1 1 Image: Comparison of the state of the s	C5, C6	2	ATC200B393MW	ATC	39000 pF chip capacitor	
C13, C14 3 27291PC Johanson 0.8-8 pF giga trim variable capacitor C12 1 ATC100B110XXXX ATC 11 pF chip capacitor TL1 L = 1.350in [34.29 mm] W = 0.082in [02.08 mm] TL2 L L = 0.144in [3.65 mm] W = 0.082in [02.08 mm] TL3 L = 0.311in [7.91 mm] W = 0.082in [02.08 mm] TL4 L = 00.82in [2.09 mm] W = 0.323in [08.21 mm]	C9	1			330 uF 50 V electrolytic capacitor	
TL1 L = 1.350in [34.29 mm] W = 0.082in [02.08 mm] TL2 L = 0.144in [3.65 mm] W = 0.082in [02.08 mm] TL3 L = 0.311in [7.91 mm] W = 0.082in [02.08 mm] TL4 L = 00.82in [2.09 mm] W = 0.323in [08.21 mm]	C13,	3	27291PC	Johanson	0.8-8 pF giga trim variable capacitor	
TL2 L = 0.144in [3.65 mm] W = 0.082in [02.08 mm] TL3 L = 0.311in [7.91 mm] W = 0.082in [02.08 mm] TL4 L = 00.82in [2.09 mm] W = 0.323in [08.21 mm]	C12	1	ATC100B110XXXX	ATC	11 pF chip capacitor	
TL3 L = 0.311in [7.91 mm] W = 0.082in [02.08 mm] TL4 L = 00.82in [2.09 mm] W = 0.323in [08.21 mm]	TL1				L = 1.350in [34.29 mm] W = 0.082in [02.08 mm]	
TL4 L = 00.82in [2.09 mm] W = 0.323in [08.21 mm]	TL2				L = 0.144in [3.65 mm] W = 0.082in [02.08 mm]	
	TL3				L = 0.311in [7.91 mm] W = 0.082in [02.08 mm]	
TL5 L = 0.194 in [4.94 mm] W = 0.323in [08.21 mm]	TL4				L = 00.82in [2.09 mm] W = 0.323in [08.21 mm]	
	TL5				L = 0.194 in [4.94 mm] W = 0.323in [08.21 mm]	

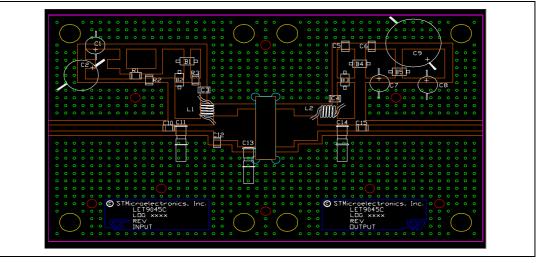
Table 8. LET9045F components list



Item	Qty	Part number	Vendor	Description	
TL6				L = 0.059in [1.49 mm] W= 0.506in [12.85 mm]	
TL7				L = 0.144in [3.65 mm] W = 0.506in [12.85 mm]	
TL8				L = 0.208in [5.28 mm] W = 0.506in [12.85 mm]	
TL9				L = 0.275in [6.98 mm] W = 0.323in [08.21 mm]	
TL10				L = 0.210in [5.33 mm] W = 0.082in [02.08 mm]	
TL11				L = 0.260in [6.60 mm] W = 0.082in [02.08 mm]	
TL12				L = 1.350in [34.29 mm] W = 0.082in [02.08 mm]	
Board 3X5	1		Rogers corp	Er=2.55 t=0.0026in h=0.030in	

Table 8. LET9045F components list (continued)







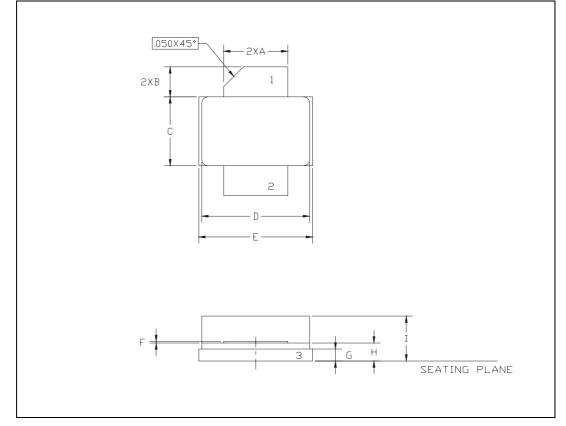
6 Package mechanical data

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Dim.		mm.			Inch	
	Min	Тур	Max	Min	Тур	Max
А	5.21		5.71	0.205		0.225
В	2.16		2.92	0.085		0.115
С	5.59		6.09	0.220		0.240
D	8.89		9.40	0.350		0.370
E	9.40		9.91	0.370		0.390
F	0.11		0.15	0.004		0.006
G	0.89		1.14	0.035		0.045
Н	1.45		1.70	0.057		0.067
I	2.67		3.94	0.105		0.155

Table 9.M250 (.230 x .360 2L N/HERM W/FLG) mechanical data

Figure 7. Package dimensions





7 Revision history

Table 10.	Document	revision	historv

Date	Revision	Changes
02-Nov-2009	1	Initial release.
11-Feb-2010	2	Changed test condition for V _{(BR)DSS} in <i>Table 4: Static</i> .
15-Apr-2011	3	Updated features in cover page.



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